EAST Search History

| Ref# | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------------|------|--|---|---------------------|---------|---------------------|
| S17 | 8 | US-20020052065-\$. DID. OR US- 20040150104-\$.DID. OR US-20030185484-\$. DID. OR US- 20040070064-\$.DID. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/03 13:57 |
| S18 | 1 | post adj electrode and interposer and interposer adj base and silicon | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/03 14:07 |
| S19 | 2 | post adj electrode and interposer and interposer adj base | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/03 14:09 |
| S20 | 8 | interposer with silicon and electronic adj element with silicon and electrode | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 15:51 |
| S21 | 5 | interposer adj base with silicon | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 16:05 |
| S 22 | 621 | interposer with silicon and (element chip die) with silicon | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 16:08 |
| \$23 | 1 | interposer with silicon and (element chip die) with silicon and post adj electrode | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 16:08 |

| S24 | 1 | interposer with silicon and (element chip die) with silicon and (post column cylindrical) adj electrode | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 16:09 |
|-----|-----|--|---|----|-----|---------------------|
| S25 | 218 | interposer with silicon and (element chip die) with silicon and electrode | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 16:09 |
| S26 | 152 | interposer with silicon and (element chip die) with silicon and electrode and @ay<"2006" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 16:09 |
| S27 | 78 | interposer with silicon and (element chip die) with silicon and electrode and @ay<"2003" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 16:10 |
| S28 | 192 | interposer with silicon and ((silicon Si) adj element chip die) and electrode and @ay<"2006" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 16:14 |
| S29 | 3 | interposer with silicon and ((silicon Si) adj element chip die) and electrode and @ay<"2006" and (post columnar cylindrical) adj electrode | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 16:18 |
| S30 | 1 | "20020052065" | US-PGPUB; USPAT | OR | OFF | 2008/12/09 16:30 |
| S31 | 12 | interposer with direct adj contact with chip | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 17:18 |

| S32 | 8 | US-20020052065-\$. DID. OR US- 20040150104-\$.DID. OR US-20030185484-\$. DID. OR US- 20040070064-\$.DID. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/09 17:26 |
|-----|----|--|---|----|-----|---------------------|
| S34 | 20 | interposer and interposer adj base and @ay<="2003" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 15:03 |
| S35 | 20 | interposer adj base and @ay<="2003" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 15:05 |
| S38 | 2 | post adj electrode and interposer and interposer adj base | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 15:33 |
| S39 | 44 | (columnar post cylindrical) adj electrode and interposer | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 15:41 |
| S40 | 20 | (columnar post cylindrical) adj electrode and interposer and @ay<="2003" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 15:41 |
| S41 | 33 | (columnar post cylindrical) adj electrode and interposer and @ay<="2005" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 15:41 |
| S42 | 58 | interposer and interposer adj base | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 16:55 |

| S43 | 58 | interposer with interposer adj base | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 16:55 |
|-----|----|---|---|----|-----|---------------------|
| S44 | 2 | interposer with base with (post cylyindrical columnar) adj electrode | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 17:32 |
| S45 | 5 | (interposer interposer adj substrate) with (post cylyindrical columnar) adj electrode | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 17:33 |
| S46 | 5 | interposer with interposer adj base with silicon | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2008/12/10 18:30 |

12/24/2008 1:40:27 PM

C:\ Documents and Settings\ tgreen1\ My Documents\ EAST\ Workspaces\ 10577017.wsp